

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20190415000.0 Datasheet for ISO1540-Q1, ISO1541-Q1 Information Only

Date: April 22, 2019 **To:** Newark/Farnell PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICEISO1540QDRQ1
ISO1541QDRQ1

CUSTOMER PART NUMBER

null null

Technical details of this Product Change follow on the next page(s).

Title: Datasheet for ISO1540-Q1, ISO1541-Q1 Customer Contact: PCN Manager Dept: Quality Services Change Type: Assembly Site Design Wafer Bump Site Assembly Materials Part number change Wafer Bump Process Mechanical Specification Test Site Wafer Fab Site Packing/Shipping/Labeling Test Process Notification Details Pescription of Change: Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. **Texas** ISO1540-Q1, ISO1541-Q1** Changed Form Original (November 2016) to Revision A Page Changed Fostures bullet From: CSA Component Acceptance Notice 5A, IEC 60950-1 and IEC 61010-1 End Equipment Standards To: CSA approval per IEC 60950-1 and IEC 62368-1 end equipment standards. 1 Updated certifications approval status, numbers, standard names, and details according to the latest agency certificates in Safety-Related Certifications table. 7 Changed both bypass capacitors From: 10 µF To: 0.1 µF in Figure 31. Even though larger capacitors can be used, 0.1 µF is the minimum recommended bypass capacitor size. 23 Changed both bypass capacitors From: 10 µF To: 0.1 µF in Figure 32. Even though larger capacitors can be used, 0.1 µF is the minimum recommended bypass capacitor size. 23 The datasheet number will be changing. Change From: Change To: SLLSEXO SLLSEXOA These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/ISO1540-Q1		
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http://www.ti.com/product/ISO1540-Q1		
Reason for Change:		
To accurately reflect device characteristics.		
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):		
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.		
Changes to product identification resulting from this PCN:		
None.		
Product Affected:		
ISO1540QD-Q1		

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN www admin_team@list.ti.com